

TRADEMARK ASSIGNMENT

Electronic Version v1.1
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT		
NATURE OF CONVEYANCE:	RELEASE BY SECURED PARTY		
CONVEYING PARTY DATA			
Name	Formerly	Execution Date	Entity Type
SILICON VALLEY BANK		02/02/2012	CORPORATION: CALIFORNIA
RECEIVING PARTY DATA			
Name:	NITRONEX CORPORATION		
Street Address:	2305 Presidential Drive		
City:	Durham		
State/Country:	NORTH CAROLINA		
Postal Code:	27703		
Entity Type:	CORPORATION: DELAWARE		
PROPERTY NUMBERS Total: 6			
Property Type	Number	Word Mark	
Registration Number:	3091510	SIGANTIC	
Registration Number:	2967342	NITRONEX	
Registration Number:	2952096	SIGANTIC	
Registration Number:	2949681	N	
Registration Number:	2925552	NITRONEX	
Serial Number:	77447606	IT'S WATTS IN THE PACKAGE	
CORRESPONDENCE DATA			
Fax Number:	(919)781-4865		
Phone:	919-781-4000		
Email:	ip@wyrick.com		
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via US Mail.</i>			
Correspondent Name:	Christopher L. Sorey		
Address Line 1:	47101 Lake Boone Trail		
Address Line 2:	Suite 300		
Address Line 4:	Raleigh, NORTH CAROLINA 27607		

OP \$165.00 3091510

ATTORNEY DOCKET NUMBER:	15455.001
NAME OF SUBMITTER:	Christopher L. Sorey
Signature:	/CLS/
Date:	02/29/2012
Total Attachments: 4 source=nitrorelease#page1.tif source=nitrorelease#page2.tif source=nitrorelease#page3.tif source=nitrorelease#page4.tif	

RELEASE OF SECURITY INTEREST IN INTELLECTUAL PROPERTY

THIS RELEASE OF SECURITY INTEREST IN INTELLECTUAL PROPERTY (the "Release") is made as of the 2 day of February 2012, between NITRONEX CORPORATION, a Delaware corporation ("Assignee"), and SILICON VALLEY BANK, a California corporation (the "Assignor").

WHEREAS, in connection with that certain Loan and Security Agreement, dated as of April 26, 2010, by and between Assignee and Assignor, Assignee and Assignor entered into certain loan and security agreements (as the same have been amended, modified, supplemented or restated, the "Agreements") for the purpose of securing certain obligations of Assignee to Assignor;

WHEREAS, pursuant to the Agreements, Assignee granted the Assignor, for the benefit of the Assignor, a security interest in all of the Patents, Trademarks, and Copyrights (as defined in the Agreements) (collectively hereinafter the "Intellectual Property"), including the Patents, Trademarks, and Copyrights, identified on Exhibits A, B, and C, attached hereto, and pledged and mortgaged (but did not transfer title to) the Intellectual Property to Assignor; and

WHEREAS, all of the indebtedness and other obligations secured by the Assignor's security interest in the Intellectual Property have been repaid in their entirety, and the Assignor is therefore obligated to release its security interest in the Intellectual Property.

NOW, THEREFORE, for valuable consideration and pursuant to the terms and conditions set forth in the Agreements:

The Assignor hereby terminates and releases its security interest in the Intellectual Property, including without limitation, the Patents, Trademarks, and Copyrights identified on Exhibits A, B, and C attached hereto, and the Assignor hereby assigns and transfers to Assignee, without any representation, warranty, or recourse whatsoever, the Assignor's entire right, title, and interest in and to the Intellectual Property, effective as of the date set forth above.

Assignor hereby agrees to execute such further instruments and documents and perform such further acts as Assignee may deem necessary to secure to Assignee the rights herein conveyed.

ASSIGNOR

SILICON VALLEY BANK

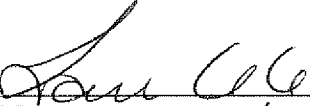
By: 
Name: Lauren Cole
Title: Vice President

EXHIBIT A

Copyrights

<u>Description</u>	<u>Registration/ Application Number</u>	<u>Registration/ Application Date</u>
NONE	N/A	N/A

EXHIBIT B

Patents

<u>Description</u>	<u>Registration/ Application Number</u>	<u>Registration/ Application Date</u>
SEMICONDUCTOR DEVICE-BASED SENSORS AND METHODS ASSOCIATED WITH THE SAME	12/023,500	1/31/2008
GALLIUM NITRIDE MATERIAL DEVICES AND METHODS OF FORMING THE SAME	11/762,985	6/14/2007
GALLIUM NITRIDE MATERIAL DEVICES INCLUDING AN ELECTROD-DEFINING LAYER AND METHODS OF FORMING THE SAME	11/477,834	6/29/2006
GALLIUM NITRIDE MATERIALS INCLUDING THERMALLY CONDUCTIVE REGIONS	11/050,598	2/3/2005
GALLIUM NITRIDE MATERIAL STRUCTURES INCLUDING ISOLATION REGIONS AND METHODS	10/879,695	6/28/2004
GALLIUM NITRIDE MATERIALS AND METHODS	10/675,798	9/30/2003
SEMICONDUCTOR STRUCTURES INCLUDING A GALLIUM NITRIDE MATERIAL COMPONENT AND A SILICON GERMANIUM COMPONENT	10/047,455	1/15/2002

EXHIBIT C

Trademarks

<u>Description</u>	<u>Registration/ Application Number</u>	<u>Registration/ Application Date</u>
SIGANTIC (Registered)	3,091,510	5/9/2006
NITRONEX (Registered)	2,967,342	7/12/2005
SIGANTIC (Registered)	2,952,096	5/17/2005
N (Registered)	2,949,681	5/10/2005
NITRONEX (Registered)	2,925,552	2/8/2005
IT'S WATTS IN THE PACKAGE (Pending)	77/447,606	4/14/2008
SIGANTIC (Abandoned)	76/211,995	2/16/2001
PENDEO (Abandoned)	75/844,687	11/9/1999
PENDEOEPITAXY (Abandoned)	75/845,791	11/9/1999
NITRONEX CORPORATION (Abandoned)	75/658,492	3/11/1999